



UPDATE CHANGE NOTIFICATION # 20289

Generic Copy

Issue Date: 07-Mar-2014

TITLE: Update Notice to IPCN 20289 - Qualify ATP as alternate source for SOIC 8lds using Cu wire for ONC35EE wafer technology.

PROPOSED FIRST SHIP DATE: N/A

AFFECTED CHANGE CATEGORY(S): Assembly bill of materials such as epoxy, gold wire and mold compound.

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or <Brandon.Becker@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

DESCRIPTION AND PURPOSE:

This update is issued to remove the qualification of ATP as alternate source for SOIC 8lds using Cu wire for ONC35EE wafer technology. We will not proceed with using ATP as an additional supplier for the part numbers listed below.

**INITIAL PRODUCT/PROCESS CHANGE NOTIFICATION #20289****List of affected General Parts:**

CAT24C08WI-G
CAT24C16WI-GT3
CAT24C04WI-GT3
CAT24C08WI-GT3
CAT25040VI-GT3
CAT24C02WI-GT3
CAT24C02WI-G
CAT24C02WI-GT3A
CAT25010VI-GT3
CAT25160VI-GT3
CAT24C02WE-GT3A
CAT24C02WI-GA
CAT24C04WI-G
CAT24C16WI-G
CAT25010VI-G
CAT25040VI-G
CAT25160VI-G
CAT24C02WE-GT3
CAT24C04WE-GT3
CAT24C08WE-GT3
CAT24C16WE-GT3
CAT25010VE-G
CAT25040VE-G
CAT25080VE-GT3
CAT25160VE-GT3
CAT24C04WE-G
CAT24C08WE-G
CAT25080VE-G
CAT24C02WE-G
CAT25010VE-GT3
CAT25160VE-G